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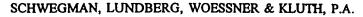
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United States Patent Application

COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that

I verily believe I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: <u>METHOD</u> <u>FOR FORMING A METALLIZATION LAYER</u>.

b. __ was filed on ___ as application serial no. ___ and was amended on _ (if applicable) (in the case of a PCT-filed application)

Th specification of which a. X is attached hereto

described and claimed in international United States patent.	tional no filed and as amended	on _ (if any), which I have revi	ewed and for which I solicit a
any amendment referred to above I acknowledge the duty to disclo Code of Federal Regulations, I hereby claim foreign priority b inventor's certificate listed belov	se information which is material to the .56 (see page 3 attached hereto). enefits under Title 35, United States (a and have also identified below any folication on the basis of which priority seen filed.	ne patentability of this application Code, §119/365 of any foreign ap foreign application for patent or i	in accordance with Title 37,
	APPLICATION(S), IF ANY, CLA	IMING PRIORITY UNDER 35	5 USC § 119
COUNTRY	APPLICATION NUMBER	DATE OF FILING (day, month, year)	DATE OF ISSUE (day, month, year)
ALL FOREIG	N APPLICATIONS, IF ANY, FILE	D REFORE THE PRIORITY	APPLICATION(S) -
COUNTRY	APPLICATION NUMBER	DATE OF FILING (day, month, year)	DATE OF ISSUE (day, month, year)
		·	<u> </u>

I hereby claim the benefit under Title 35, United States Code, § 120/365 of any United States and PCT international application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in

United States Patent Application

COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that

I verily believe I am the original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: <u>METHOD FOR FORMING A METALLIZATION LAYER</u>.

The specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

l acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56 (see page 3 attached hereto).

I hereby claim foreign priority benefits under Title 35, United States Code, \$119/365 of any foreign application(s) for patent of inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on the basis of which priority is claimed:

No such applications have been filed.

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

Application Number

Filing Date

I hereby claim the benefit under Title 35, United States Code, § 120/365 of any United States and PCT international application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

Application Number

Filing Date

Status

I hereby appoint the following attorney(s) and/or patent agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith:

Bianchi, Timothy E.	Reg. No. 39,610	Farney, W. Bryan	Reg. No. 32,651	Lempia, Bryan J.	Reg. No. 39,746
Billig, Patrick G.	Reg. No. 38,080	Fogg, David N.	Reg. No. 35,138	Lundberg, Steven W.	Reg. No. 30,568
Billion, Richard E.	Reg. No. 32,836	Forrest, Bradley A.	Reg. No. 30,837	Lynch, Michael L.	Reg. No. 30,871
Brennan, Thomas F.	Reg. No. 35,075	Forrest, Peter	Reg. No. 33,235	Schwegman, Micheal L.	Reg. No. 25,816
Burke, John E.	Reg. No. 35,836	Holloway, Sheryl S.	Reg. No. 37,850	Slifer, Russell D.	Reg. No. 39,838
Clark, Barbara J.	Reg. No. 38,107	Kalinowski, Leonard J.	Reg. No. 24,207	Viksnins, Ann S.	Reg. No. 37,748
Dryja, Michael A.	Reg. No. 39,662	Kluth, Daniel J.	Reg. No. 32,146	Woessner, Warren D.	Reg. No. 30,440
Embretson, Janet E.	Reg. No. 39,665	Lemaire, Charles A.	Reg. No. 36,198		

I hereby authorize them to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/organization/who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct Schwegman, Lundberg, Woessner & Kluth, P.A. to the contrary.

Please direct all correspondence in this case to Schwegman, Lundberg, Woessner & Kluth, P.A. at the address indicated below: P.O. Box 2938, Minneapolis, MN 55402

Telephone No. (612)339-0331







Our Ref. 303.085US1 Title: Method for Forming a Metallization Layer

Filing Date: Herewith

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 f the United States Code and that such willful false statements

may jeopardize the validi	ty of the application or any patent issued then	eon.	
Full Name of joint invent Citizenship: P st Office Address:	or number 1: <u>Gurte Singh/Sandhu</u> Great Britain 2964 East Parkriver Drive Boise, ID 83706	Residence: Boise, ID	
Signature:	Gurtej Singh Sandhu	Date:	
Full Name of joint invent Citizenship: Post Office Address:	United States of America 255 North Oakhurst Drive Apt. 33	Residence: Aurora, IL	
Signature:	Aurora, IL 60504 Chris Chang Yu Chris Chang Yu	Date: may 25, 1996	
Full Name of inventor: Citizenship: Post Office Address:		Residence:	
Signature:		Date:	
Full Name of inventor: Citizenship: Post Office Address:		Residence:	
Signature:		Date:	_



Our Ref: 303.85US1

Title: Method for Forming a Metallization Layer

Filing Date: Herewith

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the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

DATE OF FILING (day, month, year)	STATUS(patented, pending, abandoned)
·	
	DATE OF FILING (day, month, year)

I hereby appoint the following attorney(s) and/or patent agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith:

	D N - 20 (10	Fore David N	Reg. No. 35,138	Lundberg, Steven W.	Reg. No. 30,568
Bianchi, Timothy E.	Reg. No. 39,610	Fogg, David N.	Keg. 140. 33,136	Ç.	
Billig Patrick G.	Reg. No. 38,080	Forrest, Bradley A.	Reg. No. 30,837	Lynch, Michael L.	Reg. No. 30,871
Brennan, Thomas F.	Reg. No. 35,075	Forrest, Peter	Reg. No. 33,235	Schwegman, Micheal L.	Reg. No. 25,816
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Dennison, Lia Pappas	Reg. No. 34,095	Kluth, Daniel J.	Reg. No. 32,146	Woessner, Warren D.	Reg. No. 30,440
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Farney, W. Bryan	Reg. No. 32,651	Lempia, Bryan J.	Reg. No. 39,746		

I hereby authorize them to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/organization/who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct Schwegman, Lundberg, Woessner & Kluth. P.A. to the contrary.

Please direct all correspondence in this case to Schwegman, Lundberg, Woessner & Kluth, P.A. at the address indicated below:
P.O. Box 2938, Minneapolis, MN 55402
Telephone No. (612)339-0331



Our Ref: 303.85US1

Title: Method for Forming a Metallization Layer

Filing Date: Herewith

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

	Full Name of Inventor Family Name First Given Name		Second Given Name			
		SANDHU	Gurtej		Sandhu	
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I mil	Post Office Address	Post Office Address	City		State & ZipCode/Country	
. 4[]		2964 East Parkriver Drive	Boise		Idaho 83706/USA	
get pour i	Full Name of Inventor	Family Name	First Given Name		Second Given Name	
i Romer grad Romer desar		YU	Chris		Chang	
ķ.i	Residence &	City	State or Foreign Country		Country of Citizenship	
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P. mod	2801 Stewart Avenue Boise			Idaho 83702/USA		
Mer. Model the free of the first the	Full Name of Inventor	Family Name	First Given Name		Second Given Name	
203	Residence & Citizenship	City	State or Foreign Country		Country of Citizenship	
	Post Office Address	Post Office Address	City		State & ZipCode/Country	
Signature of Inventor 201 X Date Signature of Inventor 202 Signature of Inventor 203 X Date Date						

For Additional Inventors: __ Indicate here and attach sheet with same information, including date and signature.





Our Ref: 303.85US1

Title: Method for Forming a Metallization Layer

Filing Date: Herewith

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§ 1.56 Duty to disclose information material to patentability.

(a) A patent by its very nature is affected with a public interest. The public interest is best served, and the most effective patent examination occurs when, at the time an application is being examined, the Office is aware of and evaluates the teachings of all information material to patentability. Each individual associated with the filing and prosecution of a patent application has a duty of candor and good faith in dealing with the Office, which includes a duty to disclose to the Office all information known to that individual to be material to patentability as defined in this section. The duty to disclose information exists with respect to each pending claim until the claim is cancelled or withdrawn from consideration, or the application becomes abandoned. Information material to the patentability f and claim remaining under consideration in the application. There is no duty to submit information which is not material to the patentability f any existing claim. The duty to disclose all information known to be material to patentability is deemed to be satisfied if all information known to be material to patentability of any claim issued in a patent was cited by the Office or submitted to the Office in the manner prescribed by §§ 1.97(b)-(d) and 1.98. However, no patent will be granted on an application in connection with which fraud on the Office was practiced or attempted or the duty of disclosure was violated through bad faith or intentional misconduct. The Office encourages applicants to carefully examine:

- (1) prior art cited in search reports of a foreign patent office in a counterpart application, and
- the closest information over which individuals associated with the filing or prosecution of a patent application believe any pending claim patentably defines, to make sure that any material information contained therein is disclosed to the Office.
- (b) Under this section, information is material to patentability when it is not cumulative to information already of record or being made f record in the application, and
 - (1) It establishes, by itself or in combination with other information, a prima facie case of unpatentability of a claim; or
 - (2) It refutes, or is inconsistent with, a position the applicant takes in:
 - (i) Opposing an argument of unpatentability relied on by the Office, or
 - (ii) Asserting an argument of patentability.

A prima facie case of unpatentability is established when the information compels a conclusion that a claim is unpatentable under the preponderance of evidence, burden-of-proof standard, giving each term in the claim its broadest reasonable construction consistent with the specification, and before any consideration is given to evidence which may be submitted in an attempt to establish a contrary conclusion of patentability.

- (c) Individuals associated with the filing or prosecution of a patent application within the meaning of this section are:
 - (1) Each inventor named in the application:
 - (2) Each attorney or agent who prepares or prosecutes the application; and
 - (3) Every other person who is substantively involved in the preparation or prosecution of the application and who is associated with the inventor, with the assignee r with anyone to whom there is an obligation to assign the application.
- (d) Individuals other than the attorney, agent or inventor may comply with this section by disclosing information to the attorney, agent, r inventor.